# EE658: VLSI Data Conversion Circuits; HW4 

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Figure 1:

Submit all solutions by email as a single pdf file; $0.18 \mu \mathrm{~m}$ technology parameters: $V_{T n}=0.5 \mathrm{~V}$; $V_{T p}=0.5 \mathrm{~V} ; K_{n}=300 \mu \mathrm{~A} / V^{2} ; K_{p}=75 \mu \mathrm{~A} / V^{2}$; $A_{V T}=3.5 \mathrm{mV} \mu \mathrm{m} ; A_{\beta}=1 \% \mu \mathrm{~m} ; V_{d d}=1.8 \mathrm{~V} ;$ $L_{\text {min }}=0.18 \mu \mathrm{~m}, W_{\text {min }}=0.24 \mu \mathrm{~m}$; Ignore body effect unless mentioned otherwise.

1. Compute the effect of the output impedance on the single ended and differential DACs in Fig. 1. Is there a difference? What is the $G_{o} / G_{L}$ ratio that can be tolerated for $1 / 2 \mathrm{LSB}$ maximum error in a 8 bit DAC in the two cases? $G_{o}$ is the output conductance of a current source when it is on.
2. An 10 bit thermometer coded DAC is realized as shown in Fig. 2(a). Relate the standard deviation of the DNL to the standard deviation $\sigma_{I 0}$ of the relative error in each current source $\delta_{I k} / I_{0}$. Find $\sigma_{I 0}$ such that the standard deviation of DNL is 0.1 LSB.

Simulate the INL and DNL of this DAC by creating 1023 current sources with appropriate random $\delta_{I k} / I_{0}$. Repeat the simulations 32 times with independent random $\delta_{I k} / I_{0}$ each time. This is equivalent to measuring INL and DNL of 32 nominally identical DACs with random errors. Calculate the standard deviation of INL and DNL at each input code (i.e. standard deviation $\sigma_{I N L}[n]$ of $I N L[n]$ ) over the 32 DACs. Is the computed value of $\sigma_{D N L}[n]$ consistent with the calculations in the previous part? What is $\max \left(\sigma_{I N L}[n]\right) / \sigma_{I 0}$ ? How many times would you have to increase the size of the current source array in order to have $\max \left(\sigma_{I N L}[n]\right)=0.5 \mathrm{LSB}$ ?

An 10 bit binary weighted DAC is realized as shown in Fig. 2(b). It consists of 1023 current sources. Input bit $b_{k}$ controls $2^{k}$ current sources. The standard deviation $\sigma_{I 0}$ of the relative error in each current source $\delta_{I k} / I_{0}$ is the same as in the thermometer coded DAC in the previous problem. How does the INL of this DAC compare to the

INL of the thermometer coded DAC? How about the DNL? Calculate the standard deviation of the DNL at the following code transitions: a) 0111111111 to 1000000000 , and b) 0001111111 to 0010000000

(a) Thermometer DAC

(b) Binary weighted DAC

Figure 2:
3. A 8 bit thermometer coded DAC has a linear gradient in the current sources. The relative increment between two successive current sources is $2^{-11}$. Plot INL and DNL in the following cases: a) sequential switching, b) symmetrical switching, c) Random shuffling of the current sources(try 16 random permutationsplot all curves on the same plot). Report maximum INL and DNL in each case.
4. A 8 bit DAC is built using the current steering cells shown in Fig. 3.

The full scale(differential) output voltage of the DAC needs to be 1.02 V . Calculate the lower limit on the switch voltages $V_{b i}, V_{b i}^{\prime}$.

The switching voltage $V_{b i}-V_{b i}^{\prime}$ has a peak to peak value of 0.8 V . Calculate $W$ and $L$ for $M_{1}$ and $M_{2}$ for complete switching at 0.6 Vpp (to provide for some margin).

Calculate the minimum and maximum voltages
on the tail node $n_{1}$.
Assuming a $V_{G S}-V_{T}$ of 0.6 V for the tail current source, calculate its dimensions such that the standard deviation in DNL is 0.01 LSB.

Calculate the minimum supply voltage for proper operation of this circuit.


Figure 3:
5. Simulate the circuit designed in the previous problem with a power supply of 1.8 V . Use the values of swiching voltages $V_{b i}, V_{b i}^{\prime}$ calculated earlier. Simulate the configuration shown in Fig. 4(a) ${ }^{1}$

Simulate the full scale output of the DAC.
Simulate the output voltage waveform when the DAC inputs change from all zeros to all ones. Find the time required to settle to 0.25 LSB . This is the sampling period.

[^0]Simulate the output voltage waveform when the DAC inputs change from all zeros to all ones and switch back to all zeros after a sampling period. Also simulate the case where the unit cell control voltage changes from zero to one and back to zero after a sampling period. Multiply the latter waveform by 255 and overlay it on the full scale waveform. Is the larger waveform(full scale pulse) a scaled version of the smaller waveform(lsb pulse)?

Plot the waveform on the tail node as the control switches from zero to one. For the control waveforms, use a rise time that is $10 \%$ of the sampling period calculated in the previous part. Redo the simulations when the waveforms cross at the top and the bottom (Fig. 4(b)).

(a)

middle

(b)

Figure 4:
6. Dout.dat contains the digital output of a Delta Sigma A/D converter with a 4 bit quantizer and an OSR of 64. Idac.dat contains the current source values of a 4 bit DAC. The DAC is driven by the digital sequence. Overlay the spectral densities (with a 2048 point FFT) of
the digital sequence, the output when the current sources are used as a conventional DAC, and when the current sources are used as a DAC with data weighted averaging. Comment on the results.


[^0]:    ${ }^{1}$ In Fig. 4(a), the DAC is divided as a parallel combination of a unit cell and a cell that is 254 times the unit cell. Setting up 255 unit cells and simulating them with thermometer coded inputs takes a long time. Combining the cells as shown reduces the time required to setup and run the simulations

